

- Member of the Texas Instruments *Widebus™* Family
- 32-Bit Version of QS3245
- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Flow-Through Architecture Optimizes PCB Layout
- Packaged in Thin Very Small-Outline Package

### description

The SN74CBT34X245 provides 32 bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device is organized as four 8-bit bus switches, two 16-bit bus switches, or one 32-bit bus switch. When output enable ( $\overline{OE}$ ) is low, the switch is on, and port A is connected to port B. When  $\overline{OE}$  is high, the switch is open, and a high-impedance state exists between the two ports.

The SN74CBT34X245 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

**FUNCTION TABLE**  
(each 8-bit bus switch)

INPUT $\overline{OE}$	FUNCTION
L	A port = B port
H	Disconnect

**DBB PACKAGE**  
(TOP VIEW)

NC	1	80	$V_{CC}$
1A1	2	79	$1\overline{OE}$
1A2	3	78	1B1
1A3	4	77	1B2
1A4	5	76	1B3
1A5	6	75	1B4
1A6	7	74	1B5
1A7	8	73	1B6
1A8	9	72	1B7
GND	10	71	1B8
NC	11	70	$V_{CC}$
2A1	12	69	$2\overline{OE}$
2A2	13	68	2B1
2A3	14	67	2B2
2A4	15	66	2B3
2A5	16	65	2B4
2A6	17	64	2B5
2A7	18	63	2B6
2A8	19	62	2B7
GND	20	61	2B8
NC	21	60	$V_{CC}$
3A1	22	59	$3\overline{OE}$
3A2	23	58	3B1
3A3	24	57	3B2
3A4	25	56	3B3
3A5	26	55	3B4
3A6	27	54	3B5
3A7	28	53	3B6
3A8	29	52	3B7
GND	30	51	3B8
NC	31	50	$V_{CC}$
4A1	32	49	$4\overline{OE}$
4A2	33	48	4B1
4A3	34	47	4B2
4A4	35	46	4B3
4A5	36	45	4B4
4A6	37	44	4B5
4A7	38	43	4B6
4A8	39	42	4B7
GND	40	41	4B8

NC – No internal connection

PRODUCT PREVIEW



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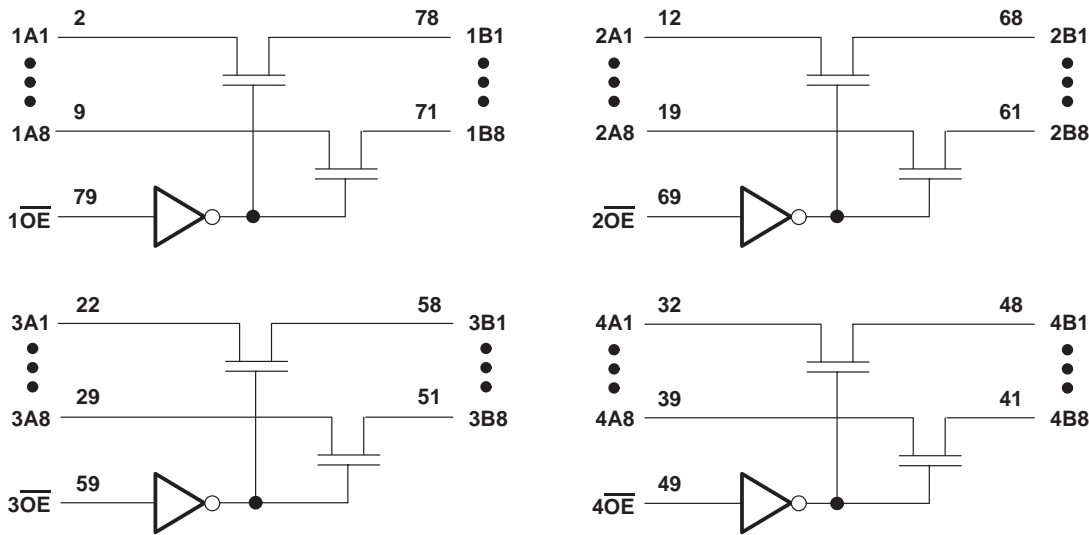
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# SN74CBT34X245 32-BIT FET BUS SWITCH

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## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Continuous channel current	128 mA
Input clamp current, $I_{IK}$ ( $V_{I/O} < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2)	64°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions (see Note 3)

	MIN	MAX	UNIT
$V_{CC}$ Supply voltage	4	5.5	V
$V_{IH}$ High-level control input voltage	2		V
$V_{IL}$ Low-level control input voltage		0.8	V
$T_A$ Operating free-air temperature	–40	85	°C

NOTE 3: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to TI application report *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2	V
$I_I$		$V_{CC} = 5.5\text{ V}$ ,	$V_I = 5.5\text{ V}$ or GND			$\pm 5$	$\mu\text{A}$
$I_{CC}$		$V_{CC} = 5.5\text{ V}$ ,	$I_O = 0$ , $V_I = V_{CC}$ or GND			50	$\mu\text{A}$
$\Delta I_{CC}^\ddagger$	Control inputs	$V_{CC} = 5.5\text{ V}$ ,	One input at 3.4 V, Other inputs at $V_{CC}$ or GND			3.5	mA
$C_i$	Control inputs	$V_I = 3\text{ V}$ or 0					pF
$C_{io}(\text{OFF})$		$V_O = 3\text{ V}$ or 0, $\overline{OE} = V_{CC}$					pF
$r_{on}^\S$		$V_{CC} = 4\text{ V}$ , TYP at $V_{CC} = 4\text{ V}$	$V_I = 2.4\text{ V}$ , $I_I = 15\text{ mA}$				$\Omega$
		$V_{CC} = 4.5\text{ V}$	$V_I = 0$ , $I_I = 64\text{ mA}$				
			$I_I = 30\text{ mA}$				
			$V_I = 2.4\text{ V}$ , $I_I = 15\text{ mA}$				

† All typical values are at  $V_{CC} = 5\text{ V}$  (unless otherwise noted),  $T_A = 25^\circ\text{C}$ .

‡ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

§ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

**switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

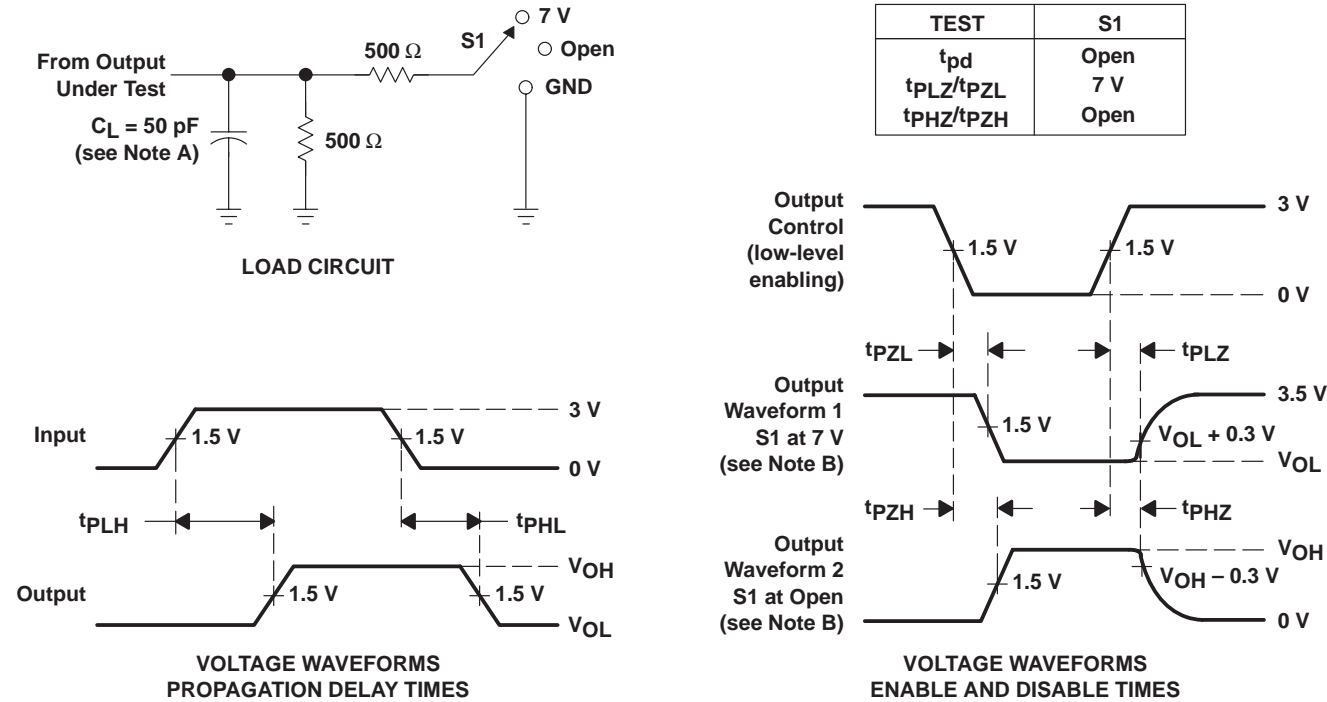
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4\text{ V}$		$V_{CC} = 5\text{ V} \pm 0.5\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	
$t_{pd}^\P$	A or B	B or A					ns
$t_{en}$	$\overline{OE}$	A or B					ns
$t_{dis}$	$\overline{OE}$	A or B					ns

¶ The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

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## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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